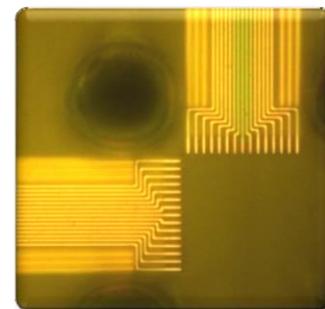
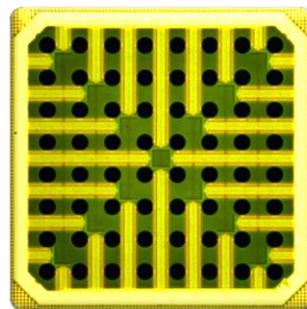
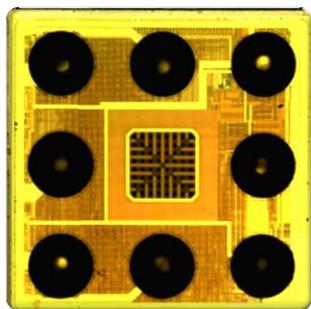


TMP006

Infrared Thermopile Sensor



Product Analysis Report

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To Know



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